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AL3158

HIGH EFFICIENCY 1x/2x CHARGE PUMP FOR WHITE LED APPLICATIONS

Description

The DIODES™ AL3158 is a low noise, constant frequency charge pump DC/DC converter that uses a dual mode load switch (1x), and (2x) conversion for white LED applications. The AL3158 is capable of driving three groups of three LED channels at 20mA from a 2.7V to 5.5V input. The current sinks may be operated using three simple PWM dimming inputs individually or in parallel for driving higher-current LEDs. Low external part counts (one 1µF flying capacitor and two 2.2µF capacitors at V_{IN} and V_{OUT}) make this part ideally suited for small, battery-powered applications.

AL3158 PWM dimming inputs are used to enable, disable device and dimming LED current with a fixed default current settings at 20mA or other factory programming options available.

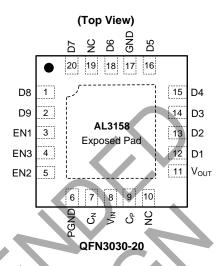
Each output of the AL3158 is equipped with built-in protection for V_{OUT} short circuit and auto-disable for LED short conditions. Built-in soft-start circuitry prevents excessive inrush current during start-up and mode switching. A low-current shutdown feature disconnects the load from V_{IN} to reduce quiescent current less than $1\mu A$.

The AL3158 is available in a lead-free, space-saving, thermally enhanced 20-pin 3 x 3mm QFN3030-20 package.

Features

- V_{IN} Range: 2.7V to 5.5V
- Up to 93% Max Power Efficiency
- 1% Current Matching Accuracy Between Channels
- Three Simple PWM Dimming for RGB or WLED
- Low Transition Threshold Voltage Typical 150mV
- Dual-Mode 1x and 2x Charge Pump
- Drives up to 3 + 3 + 3 Channels of LEDs
- 1.2MHz Constant Switching Frequency
- Vout Short Circuit and Thermal Protections
- · Soft Start for Reducing Inrush Current
- Under Voltage Lockout Protection
- I_Q < 1μA in Shutdown
- Thermally-Enhanced QFN3030-20 Package: Available in "Green" Molding Compound (No Br, Sb)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Pin Assignments



Applications

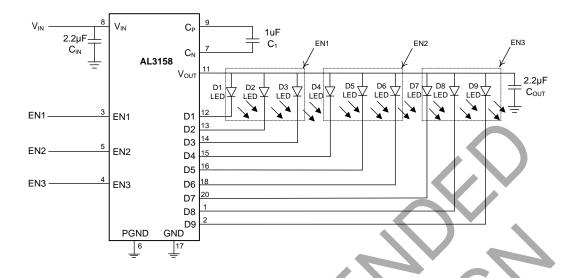
- Mobile phone white LED backlighting and indicators
- PDA white LED backlighting
- Battery-operated phone main and sub screen white LED backlighting

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Typical Application Circuit

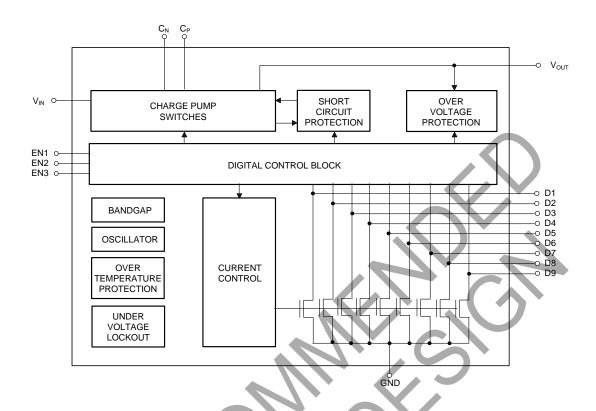


Pin Descriptions

Pin Name	Pin Number	Description
D8	1	Current Sink Input #8. Connected to VouT when unused.
D9	2	Current Sink Input #9. Connected to Vout when unused.
EN1	3	Enable Pin 1
EN3	4	Enable Pin 3
EN2	5	Enable Pin 2
PGND	6	Charge Pump Switch Ground
C _N	7	Negative Terminal of Flying Capacitor
Vin	8	Input Power Supply. Requires 2.2µF capacitor between this pin and ground.
СР	9	Positive Terminal of Flying Capacitor
NC	10, 19	No-Connect No-Connect
Vout	11	Charge Pump Output to Drive Load Circuit. Requires 2.2µF capacitor between this pin and ground.
D1	12	Current Sink Input #1. Connected to VouT when unused.
D2	13	Current Sink Input #2. Connected to Vout when unused.
D3	14	Current Sink Input #3. Connected to V _{OUT} when unused.
D4	15	Current Sink Input #4. Connected to Vout when unused.
D5	16	Current Sink Input #5. Connected to Vout when unused.
GND	17	Ground
D6	18	Current Sink Input #6. Connected to Vout when unused.
D7	20	Current Sink Input #7. Connected to V _{OUT} when unused.
Exposed Pad	EP Pad	Exposed Pad (bottom). Connected to GND directly underneath the package.



Functional Block Diagram



Absolute Maximum Ratings (Note 4)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD MM	Machine Model ESD Protection	200	V
Vin	Input Voltage	-0.3 to 6	V
VEN1,2,3	EN1, EN2, EN3 to GND Voltage	-0.3 to V _{IN} +0.3	V
Іоит	Maximum DC Output Current	270	mA
TJ	Operating Junction Temperature	+150	°C
TLEAD	Maximum Soldering Temperature (at leads, 10 sec)	+300	°C

Note:

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{IN}	Input Voltage	2.7	5.5	V
TA	Operating Ambient Temperature	-40	+85	°C

^{4.} Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.



Electrical Characteristics ($T_A = +25$ °C, $V_{IN} = 3.6$ V, $C_{IN} = C_{OUT} = 2.2\mu F$, $C_1 = 1\mu F$, unless otherwise noted.)

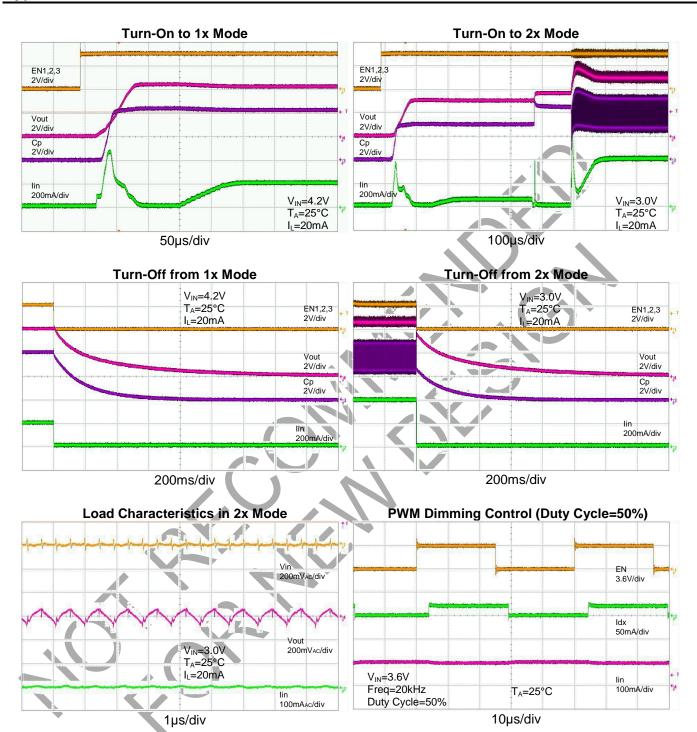
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
1-	Quiescent Current	1x Mode, 3.0 ≤ V _{IN} ≤ 5.5, Active No Load Current	_	0.3	0.6	- mA
IQ	Quiescent Current	2x Mode, 3.0 ≤ V _{IN} ≤ 5.5, Active No Load Current	_	2	5	MA
I _{SHDN}	Shutdown Current	EN1, EN2, EN3 = 0	_	_	1	μΑ
I _{DX}	I _{SINK} Current Accuracy (Note 5)	_	19	20	21	mA
I _{D-Match}	Current Matching Between Any Two Current Sink Inputs (Note 6)	V _F : D1:D9 = 3.6V	_	1	2	%
Rout	Open Loop Vout Resistance	1x Mode	-/	0.5		Ω
ROUI	Open Loop Voul Resistance	2x Mode		4.5		77
Vтн	1x to 2x Transition Threshold at Any Isink Pin	I _D X = 20mA		150	I	mV
VHS	Mode Transition Hysteresis	_		250		mV
tss	Soft-Start Time	_)— `	100		μs
fsw	Switching Frequency	_	_	1.2		MHz
VEN1, 2, 3 (L)	EN1, 2, 3 Threshold Low	V _{IN} = 2.7V	_		0.4	V
VEN1, 2, 3 (H)	EN1, 2, 3 Threshold High	VIN = 5.5V	1.4	7/	_	V
ten1, 2, 3	EN1, 2, 3 Off Timeout	_		-	20	ms
UVLO	V _{IN} Under-Voltage Lockout	- \ \	1.8	2	2.2	V
len1, 2, 3	EN1, 2, 3 Input Leakage	-11/11	-1	_	1	μΑ
Tshon	Thermal Shutdown Protection	- 1	_	+160	_	°C
T _{HYS}	Thermal Shutdown Hysteresis		_	+10	_	°C
θЈА	Thermal Resistance Junction-to-Ambient	QFN3030-20 (Note 7)	_	52	_	°C/W

Notes:

- 5. Determined by the average current levels of all active channels.
 6. Determined by the maximum sink current (MAX), the minimum sink current (MIN), and the average sink current (AVG). Two matching numbers are calculated as (MAX-AVG)/AVG and (AVG-MIN)/AVG. The largest number of the two (worst case) is considered as the matching data.
 7. Device mounted on FR-4 substrate, 2" x 2", 2oz copper, double-sided PC board, with minimum recommended pad on top layer and 4 vias to bottom layer.

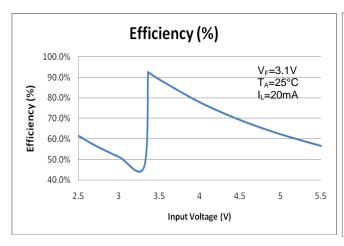


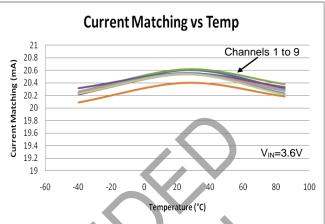
Typical Performance Characteristics

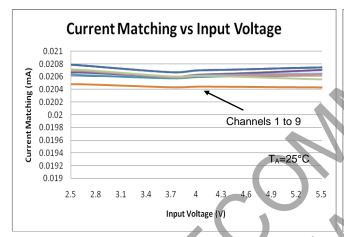


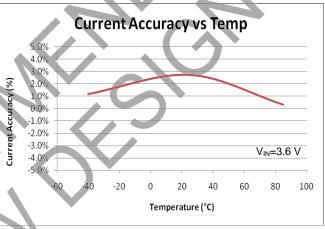


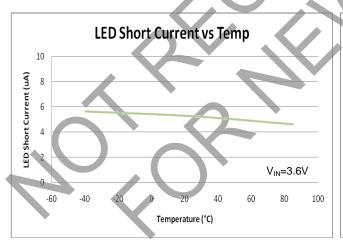
Typical Performance Characteristics (continued)

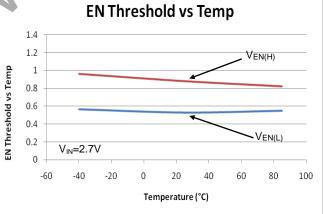














Functional Description

The AL3158 is a dual-mode high efficiency charge pump (1x and 2x) device, driving three groups of three LED channels at 30mA maximum each, intended for white LED backlight applications. An internal comparator circuit compares the voltage at each constant current sink input against a reference voltage. To ensure maximum power efficiency, the most appropriate switching mode (1x and 2x) is automatically selected.

The AL3158 requires only three external components: one 1µF ceramic flying capacitor (C₁) for the charge pump, one 2.2µF ceramic input capacitor (C_{IN}), and one 2.2µF ceramic charge pump output capacitor (C_{OUT}).

Each output channel of the AL3158 can drive three groups of three individual LED channels with a maximum current of fixed manufacture setting (20mA or 30mA) per channel. These can be paralleled to give a total output current of 270mA.

EN <3:1>	LED ON/OFF CONTROL	
XX0	LED1 to LED3 OFF	
XX1	LED1 to LED3 ON	
X0X	LED4 to LED6 OFF	
X1x	LED4 to LED6 ON	
0XX	LED7 to LED9 OFF	
1xX	LED7 to LED9 ON	

Disabled Current Sinks

Unused current channels must be disabled by connecting the sinks to Vour with only a small sense current flowing through the disabled channel.

Soft-Start

Soft-start is incorporated to prevent excessive inrush current during power-up, mode switching, and transitioning out of stand-by mode.

Short-Circuit Protection

Short-circuit protection function is incorporated to prevent excessive load current when either flying cap terminals or output pin electrically tied to a very lower voltage or ground.

Over-Voltage Protection

Over-voltage protection function is incorporated to limit the output voltage under a safe value to avoid on-chip device breakdown.

Under-Voltage Lockout

Under-voltage lockout feature disables the device when the input voltage drops below UVLO threshold.

Thermal Auto Shutdown

When the die temperature exceeds the thermal limit, the device will be disabled and enter stand-by mode. The operation resumes whenever the die cools off sufficiently.

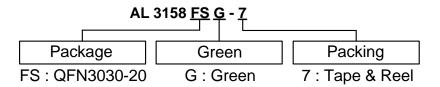
PWM Dimming Control

The AL3158 provides simple PWM dimming control through ENx pins, and the current is adjusted by the duty cycle of the signal applied on ENx pin. The recommended PWM frequency is from 200Hz to 50kHz depending on applications.

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Ordering Information



Part Number	Part Number Suffix	Daakana Cada	Dookses (Note 9)	Pac	king
Part Number	Part Number Sumx	Package Code	Package (Note 8)	Qty.	Carrier
AL3158FSG-7	-7	FS	QFN3030-20	3000	7" Tape & Reel

8. Pad layout as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html. Note:

Marking Information

QFN3030-20

(Top View)

XX**YWX** XX : B8 : AL3158 Y : Year : 0 to 9 (ex: 2 = 2022) W : Week : A to Z : week 1 to 26; a to z : week 27 to 52; z represents

week 52 and 53 <u>X</u> : A to Z : Green

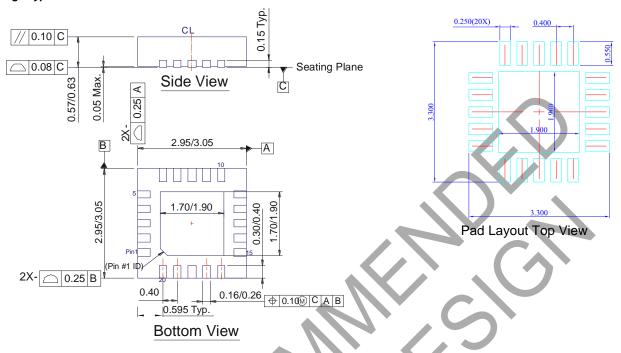
Part Number	Package	Identification Code
AL3158FSG-7	QFN3030-20	B8



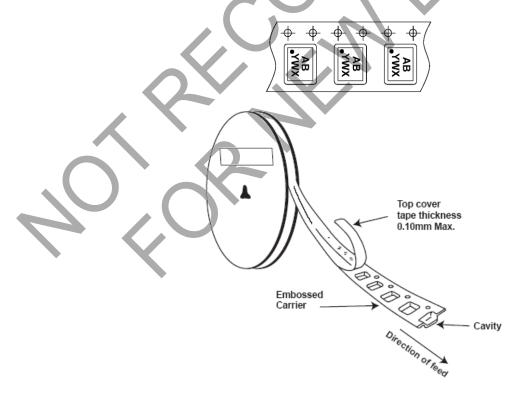
Package Outline Dimensions (All Dimensions in mm)

Please see http://www.diodes.com/package-outlines.html for the latest version.

Package Type: QFN3030-20



Taping Orientation (Note 9)



Note: 9. The taping orientation of the other package type can be found on our website at https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf.



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